



20V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = 25°C
	$56mΩ @ V_{GS} = 4.5V$	2.8A
20V	$65m\Omega @ V_{GS} = 2.5V$	2.6A
	93mΩ @ V _{GS} = 1.8V	2.2A
	140mΩ @ V _{GS} = 1.5V	1.8A

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 standards for High Reliability

Description and Applications

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- General Purpose Interfacing Switch
- Power Management Functions
- DC-DC Converters
- Analog Switch

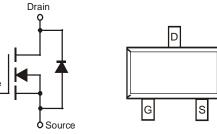
Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram

Top View

- Terminals: Finish Matte Tin annealed over Alloy42 leadframe.
 Solderable per MIL-STD-202, Method 208
- Weight: 0.027 grams (approximate)





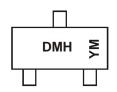
Ordering Information (Note 3)

Part Number	Case	Packaging	
DMN2065UW-7	SOT323	3000/Tape & Reel	

Notes: 1. No purposefully added lead.

- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



DMH = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

Date Code Key

Year	2011	1	2012		2013	20	14	2015		2016		2017
Code	Υ		Z		Α	[3	С		D		Е
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V_{DSS}	20	V		
Gate-Source Voltage			V_{GSS}	±12	V
Continuous Drain Current (Note 5) V 45V	Steady State	$T_A = 25$ °C $T_A = 70$ °C	I _D	2.8 2.3	А
Continuous Drain Current (Note 5) V _{GS} = 4.5V	t<10s	$T_A = 25$ °C $T_A = 70$ °C	I _D	3.1 2.6	А
Continuous Drain Current (Note EV) 4 9V	Steady State	$T_A = 25$ °C $T_A = 70$ °C	I _D	2.2 1.7	Α
Continuous Drain Current (Note 5) V _{GS} = 1.8V	t<10s	T _A = 25°C T _A = 70°C	I _D	2.4 1.9	А
Pulsed Drain Current (10us pulse, duty cycle=1%)	I _{DM}	30	Α		
Maximum Body Diode Forward Current (Note 4)	I _S	1.2	Α		

Thermal Characteristics @T_A = 25°C unless otherwise specified

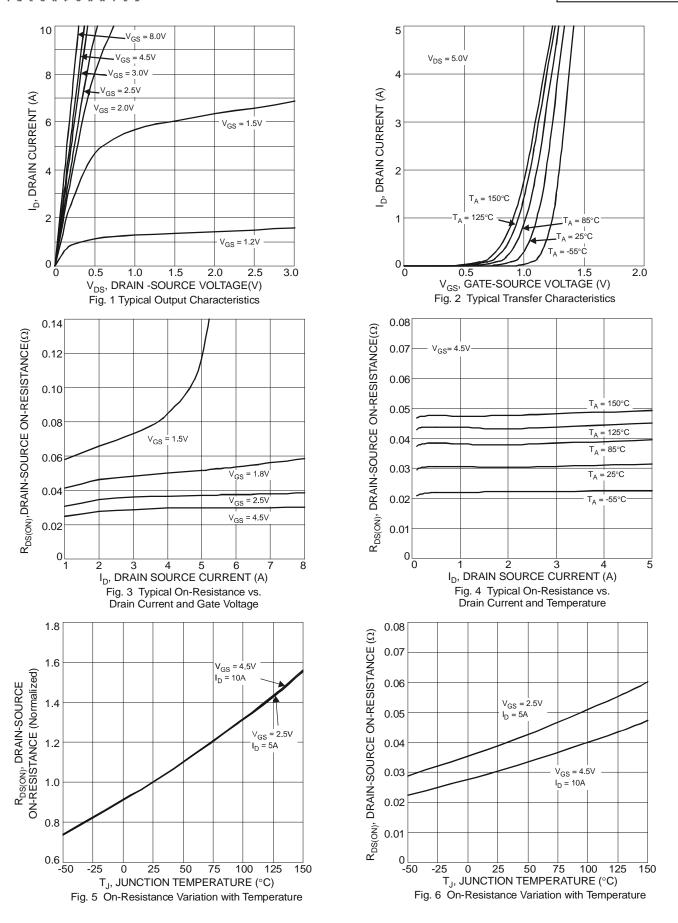
Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 4)		P_{D}	0.43	W
Thermal Resistance, Junction to Ambient (Note 4)	Steady state	D	296	°C/W
Thermal Resistance, Junction to Ambient (Note 4)	t<10s	$R_{\theta JA}$	252	°C/W
Total Power Dissipation (Note 5)		P_{D}	0.7	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	Б	178	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	151	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

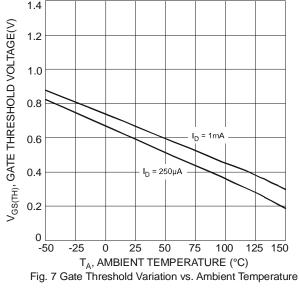
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage		BV_{DSS}	20	-	-	V	$V_{GS} = 0V$, $I_D = 1mA$
Zero Gate Voltage Drain Current	$@T_c = 25^{\circ}C$	I _{DSS}	-	-	1	μΑ	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage		I _{GSS}	-	-	±1	μA	$V_{GS} = \pm 10V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage		$V_{GS(th)}$	0.35	-	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
			-	52	56		$V_{GS} = 4.5V, I_D = 2A$
Static Drain-Source On-Resistance		D	-	59	65	mΩ	$V_{GS} = 2.5V, I_D = 2A$
Static Drain-Source On-Resistance		R _{DS (ON)}	-	60	93	11177	$V_{GS} = 1.8V, I_D = 1A$
			-	75	140		$V_{GS} = 1.5V, I_D = 0.5A$
Forward Transfer Admittance		Y _{fs}	-	7	-	S	$V_{DS} = 5V, I_{D} = 3.8A$
Diode Forward Voltage		V _{SD}	-	0.7	1.0	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance		C _{iss}	-	400.0	-	pF	V 40V V 0V
Output Capacitance		Coss	-	73.8	-	pF	$V_{DS} = 10V, V_{GS} = 0V,$ -f = 1.0MHz
Reverse Transfer Capacitance		Crss	-	65.6	-	pF	71 = 1.0IVIH2
Total Gate Charge		Qg	-	5.4	-	nC	V _{GS} = 4.5V, V _{DS} = 10V,
Gate-Source Charge		Q_{gs}	-	0.7	-	nC	I _D = 6A
Gate-Drain Charge		Q _{gd}	-	1.4	-	nC	
Turn-On Delay Time		t _{D(on)}	-	3.5	-	ns	
Turn-On Rise Time	Turn-On Rise Time		-	9.7	-	ns	$V_{DD} = 10V, V_{GS} = 5V,$
Turn-Off Delay Time		t _{D(off)}	-	23.8	-	ns	$R_L = 1.7\Omega$, $R_G = 6\Omega$,
Turn-Off Fall Time		t _f	-	7.2	-	ns	

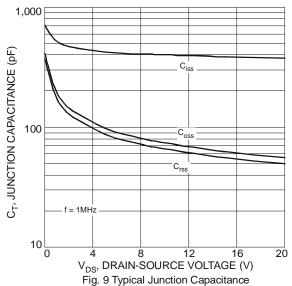
Device mounted on FR-4 substrate PC board, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.

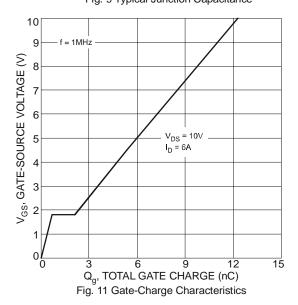


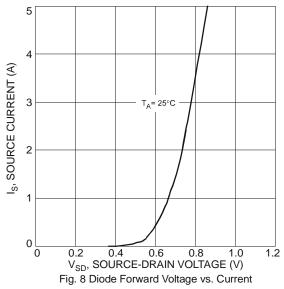












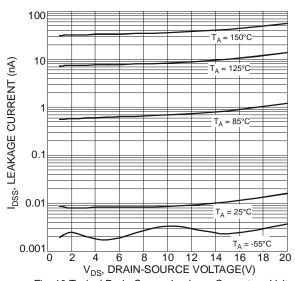
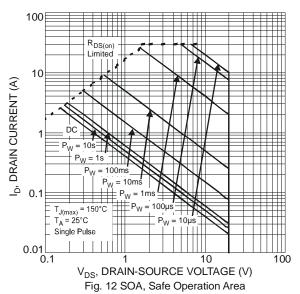
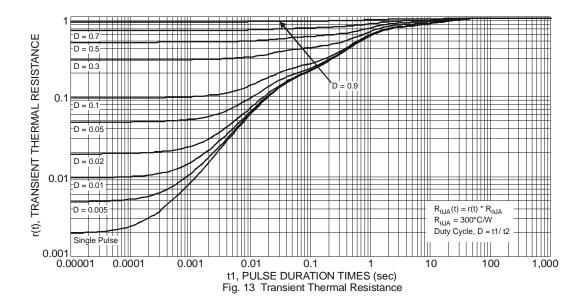


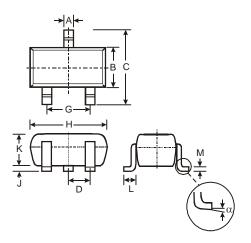
Fig. 10 Typical Drain-Source Leakage Current vs. Voltage





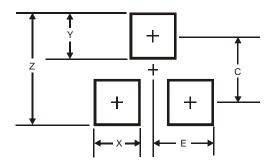


Package Outline Dimensions



SOT323							
Dim	Min	Max	Тур				
Α	0.25	0.40	0.30				
В	1.15	1.35	1.30				
С	2.00	2.20	2.10				
D	-	-	0.65				
G	1.20	1.40	1.30				
Н	1.80	2.20	2.15				
J	0.0	0.10	0.05				
K	0.90	1.00	1.00				
L	0.25	0.40	0.30				
M	0.10	0.18	0.11				
α	0°	8°	-				
All Dimensions in mm							

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Y	0.9
С	1.9
Е	1.0



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